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SUBMISSION TYPE:	CORRECTIVE ASSIGNMENT
NATURE OF CONVEYANCE:	Corrective Assignment to correct the Addition of Assignee Masanobu Yamamoto previously recorded on Reel 015077 Frame 0548. Assignor(s) hereby confirms the Assignment of Assignor's Interest.

CONVEYING PARTY DATA

Name	Execution Date
Kotaro Kurokawa	10/15/2003
Takeshi Yamasaki	10/17/2003
Tomomi Yukomoto	10/17/2003
Masanobu Yamamoto	10/17/2003
Daisuke Ueda	10/17/2003

RECEIVING PARTY DATA

Name:	Sony Corporation	
Street Address:	7-35 Kitashinagawa 6-Chome	
Internal Address:	Shinagawa-Ku	
City:	Tokyo	
State/Country:	JAPAN	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	10475070

CORRESPONDENCE DATA

Fax Number: (312)422-9033

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Email: robert.depke@hklaw.com

Correspondent Name: Robert J. Depke

Address Line 1: HOLLAND & KNIGHT LLP

Address Line 2: 131 S DEARBORN ST., 30TH FLOOR

Address Line 4: CHICAGO, ILLINOIS 60603

NAME OF SUBMITTER: Robert J. Depke

Total Attachments: 2

PATENT REEL: 015435 FRAME: 0393

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> PATENT REEL: 015435 FRAME: 0394

403P0189U900 (02/8079)

Docket Number:	075834.00302	

ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in INITIALIZATION METHOD OF OPTICAL RECORDING MEDIUM

for which an application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 7-35 Kitashinagawa 6-Chome, Shinagawa-Ku, Tokyo 141-0001 Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, the entire right, title and interest in the said invention, said application, including any divisions and continuations as well as any reissues and reexaminations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial No. PCT/JP03/01771 Filing Date February 19, 2003

This assignment executed on the dates indicated below.

Kotaro KUROKAWA	
Name of first or sole inventor	Execution date of U.S. Patent Application
Kanagawa, Japan Residence of first or sole inventor	
Kotaro Kurohawa	October 15, 2003
Signature of First or sole inventor	Date of this Assignment

Takeshi YAMASAKI	
Name of second inventor	Execution date of U.S. Patent Application
Kanagawa, Japan	
Residence of second inventor	
Signature of second inventor yamasaki	October 17, 2003 Date of this Assignment
y	Date of this Assignment
Tomom: VIII/IIIIOTO	
Tomomi YUKUMOTO Name of third inventor	
The same of the sa	Execution date of U.S. Patent Application
Chiba, Japan	
Residence of third inventor	
Signature of third inventor	A. (/n z
Signature of third inventor	October 17, 2003 Date of this Assignment
	o
Masanobu YAMAMOTO	
Name of tourth inventor	Execution date of U.S. Patent Application
Kanagawa, Japan	
Residence of fourth inventor	
	41
Signature of Fourth inventor Janamo o	October 17, 2003 Date of this Assignment
organitate of fourth inventor	Date of this Assignment
- 1	
Daisuke UEDA Name of fifth inventor	
Table of filli inventor	Execution date of U.S. Patent Application
Tokyo, Japan	
Residence of fifth inventor	
Daisuke Veda	Oct. 17 7003
Signature of fifth inventor	October 17, 2003 Date of this Assignment
Name of sixth inventor	Execution date of U.S. Patent Application
	France
Residence of sixth inventor	
Signature of sixth inventor	
aguature of sixth inventor	Date of this Assignment
Name of seventh inventor	
varie of sevenin inventor	Execution date of U.S. Patent Application
Residence of seventh inventor	
signature of seventh inventor	Date of this Assignment

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RECORDED: 12/10/2004

PATENT REEL: 015435 FRAME: 0396